



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

2SB1205 — PNP Epitaxial Planar Silicon Transistor

Strobe High-Current Switching Applications

Applications

- Flash, voltage regulators, relay drivers, lamp drivers

Features

- Adoption of FBET, MBIT processes
- Fast switching speed
- Small and slim package making it easy to make 2SB1205-applied sets smaller
- Low saturation voltage
- Large current capacity

Specifications

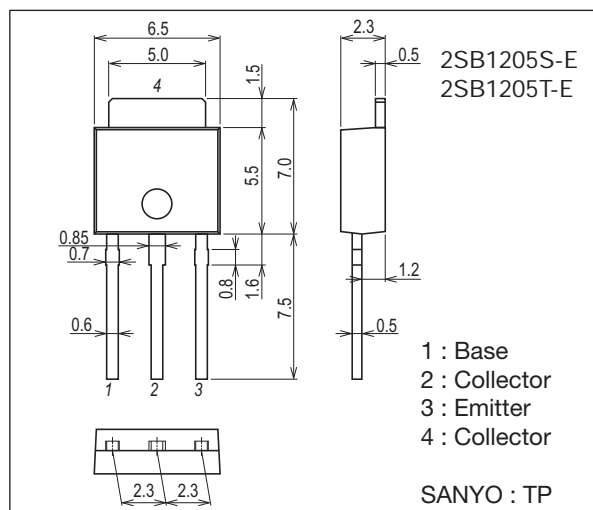
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V _{CB0}		-25	V
Collector-to-Emitter Voltage	V _{CE0}		-20	V
Emitter-to-Base Voltage	V _{EB0}		-5	V
Collector Current	I _C		-5	A
Collector Current (Pulse)	I _{CP}		-8	A

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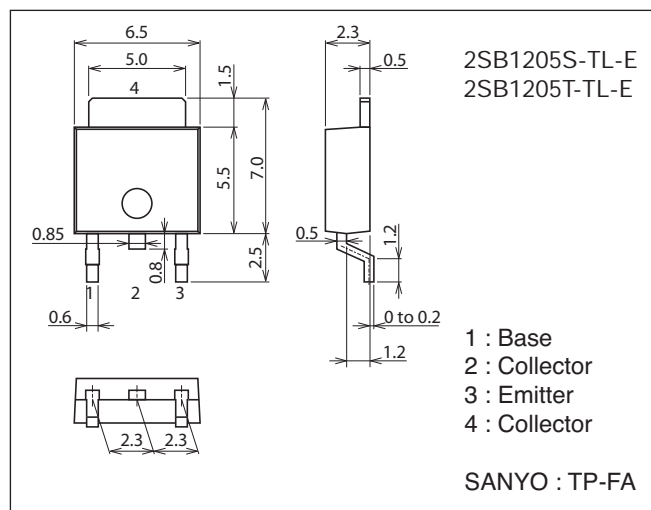
Package Dimensions unit : mm (typ)

7518-003



Package Dimensions unit : mm (typ)

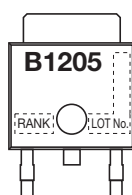
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Product & Package Information

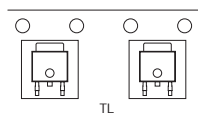
- Package : TP
- JEITA, JEDEC : SC-64, TO-251
- Minimum Packing Quantity : 500 pcs./bag

Marking (TP, TP-FA)

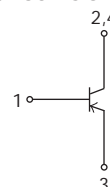


- Package : TP-FA
- JEITA, JEDEC : SC-63, TO-252
- Minimum Packing Quantity : 700 pcs./reel

Packing Type (TP-FA) : TL



Electrical Connection



SANYO Semiconductor Co., Ltd.

<http://www.sanyosemi.com/en/network/>

2SB1205

Continued from preceding page.

Parameter	Symbol	Conditions	Ratings	Unit
Base Current	I_B		-0.5	A
Collector Dissipation	P_C		1	W
		$T_C=25^{\circ}\text{C}$	10	W
Junction Temperature	T_J		150	$^{\circ}\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^{\circ}\text{C}$

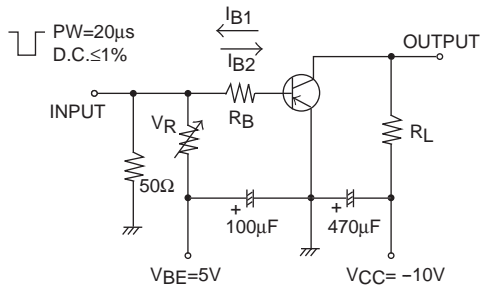
Electrical Characteristics at $T_a=25^{\circ}\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=-20\text{V}, I_E=0\text{A}$			-500	nA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=-4\text{V}, I_C=0\text{A}$			-500	nA
DC Current Gain	h_{FE1}	$V_{CE}=-2\text{V}, I_C=500\text{mA}$	100*		400*	
	h_{FE2}	$V_{CE}=-2\text{V}, I_C=-4\text{A}$	60			
Gain-Bandwidth Product	f_T	$V_{CE}=-5\text{V}, I_C=-200\text{mA}$		320		MHz
Output Capacitance	C_{ob}	$V_{CB}=-10\text{V}, f=1\text{MHz}$		60		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-3\text{A}, I_B=-60\text{mA}$		-250	-500	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=-3\text{A}, I_B=-60\text{mA}$		-1.0	-1.3	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=-10\mu\text{A}, I_E=0\text{A}$	-25			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=-1\text{mA}, R_{BE}=\infty$	-20			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=-10\mu\text{A}, I_C=0\text{A}$	-5			V
Turn-On Time	t_{on}	See specified Test Circuit.		40		ns
Storage Time	t_{stg}			200		ns
Fall Time	t_f			10		ns

* : The 2SB1205 is classified by 500mA h_{FE} as follows :

Rank	R	S	T
h_{FE}	100 to 200	140 to 280	200 to 400

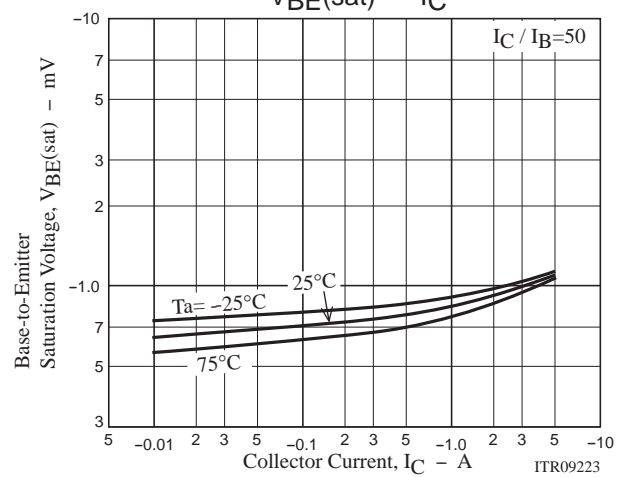
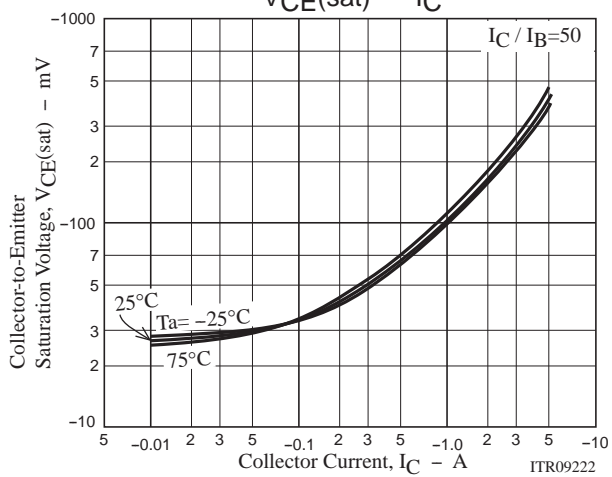
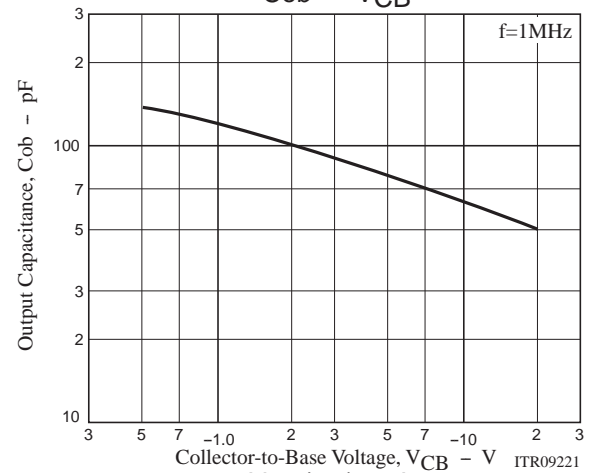
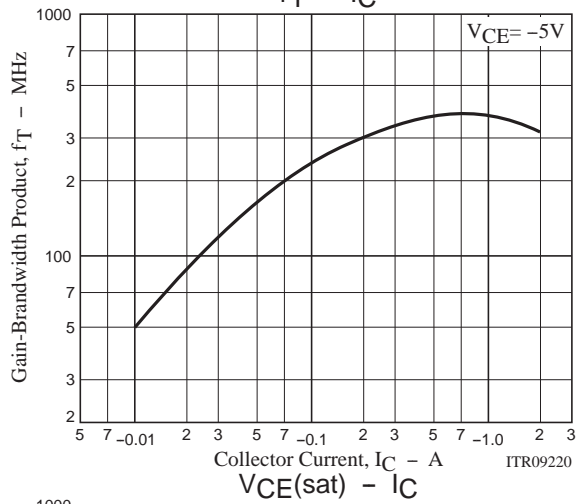
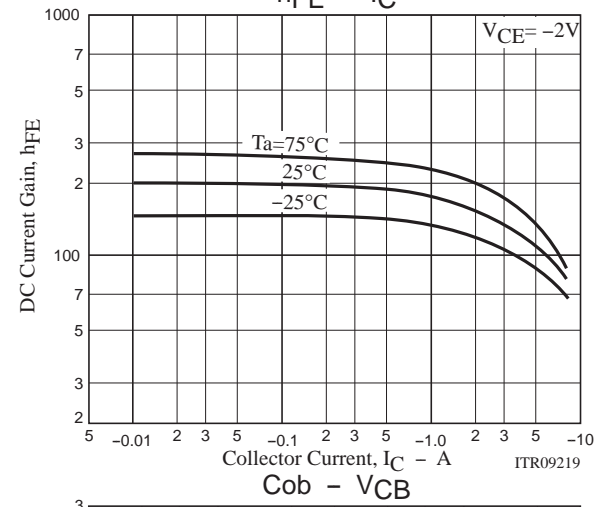
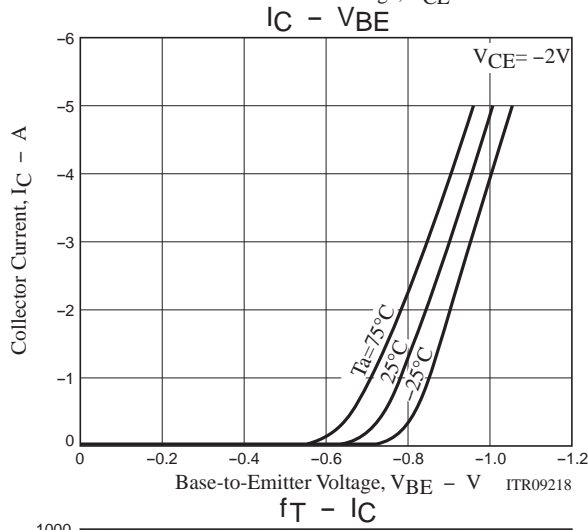
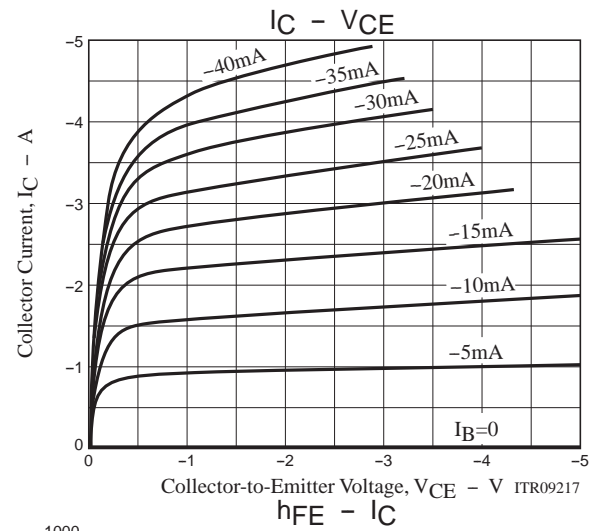
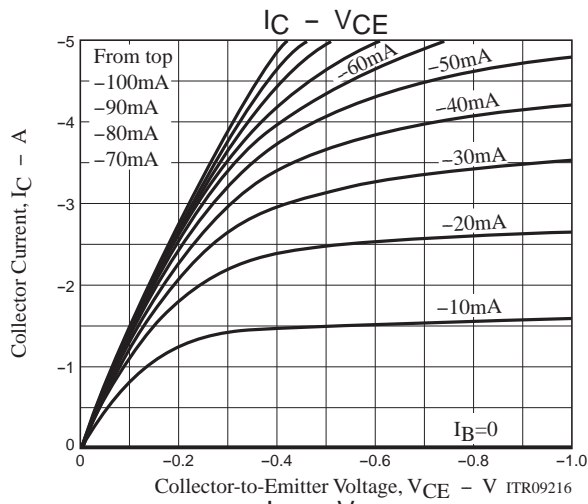
Switching Time Test Circuit

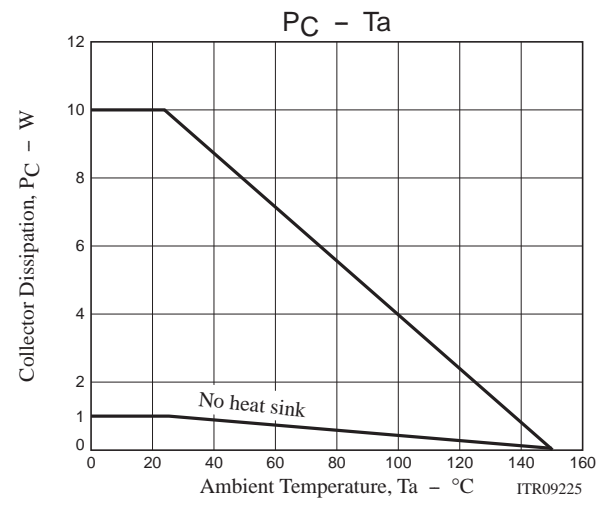
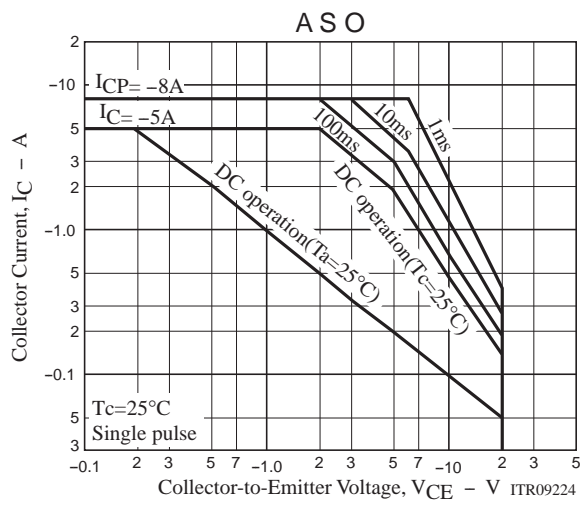


$$I_C=10I_{B1}=-10I_{B2}=-2\text{A}$$

Ordering Information

Device	Package	Shipping	memo
2SB1205S-E	TP	500pcs./bag	Pb Free
2SB1205T-E	TP	500pcs./bag	
2SB1205S-TL-E	TP-FA	700pcs./reel	
2SB1205T-TL-E	TP-FA	700pcs./reel	





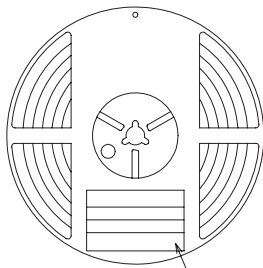
Taping Specification

2SB1205S-TL-E, 2SB1205T-TL-E

Packing Format

Package Name	Carrier Type Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
TP-FA	TP	700	2,100	12,600	3 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method



Reel label

Type No.
LOT No.
Quantity
Origin

Reel label, Inner box label
(unit:mm)

(P) TYPE	000000000
(1) LOT	00
(Q) QTY	0,000 (1) LEAD FREE *
(Z) SPECIAL	
	20722005310C
	ASSEMBLY:**** (DIFFUSION:****)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process.

TYPE CODE	
	oooooooooooo
TYPE	○○○○○○○○
QTY	0,000 PCS (1) LEAD FREE *
LOT	○○○○○○○○
PACKAGE	○○○○○○○○
SPECIAL	
	20722005310C
	ASSEMBLY:**** (DIFFUSION:****)

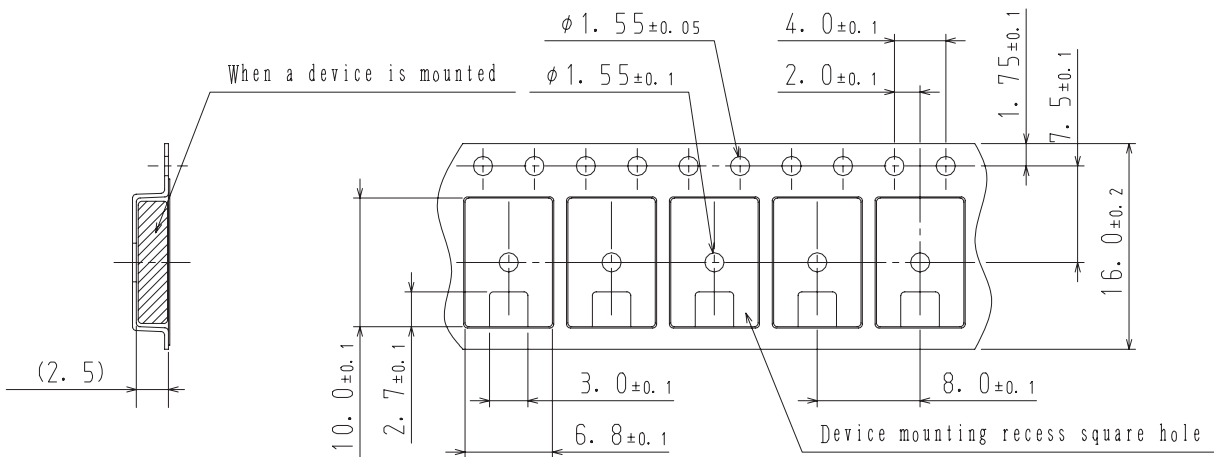
NOTE (1)

The LEAD FREE * description shows that the surface
treatment of the terminal is lead free.

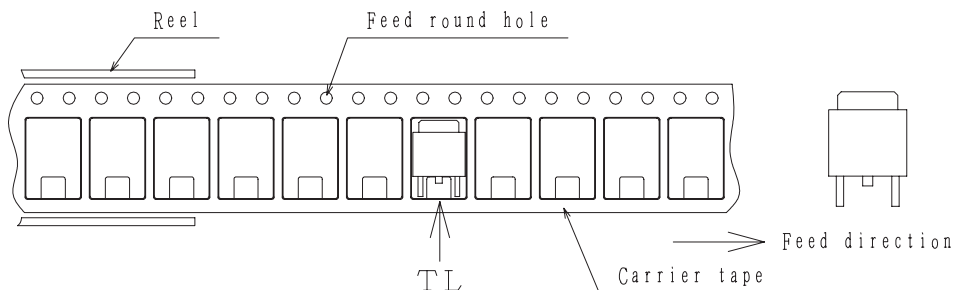
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

Taping configuration

1. Carrier tape size (unit:mm)

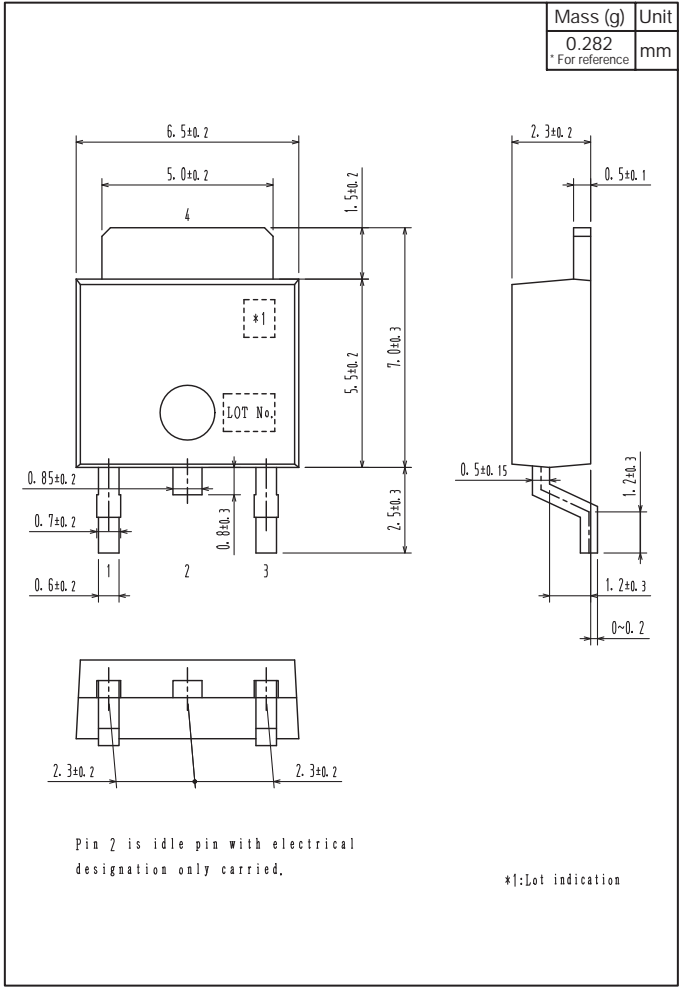


2. Device placement direction

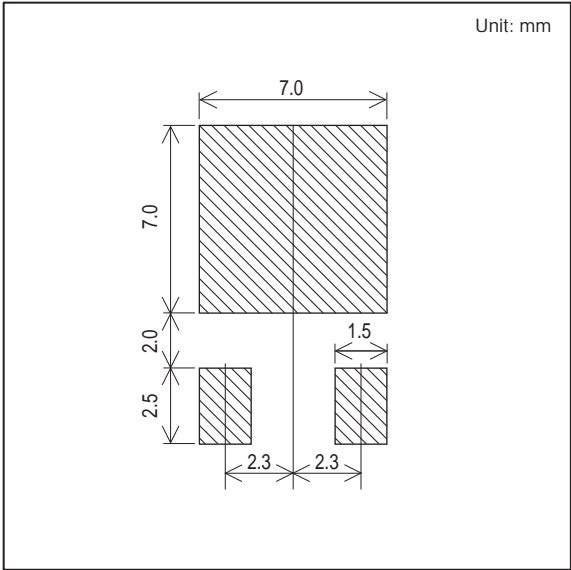


Those with one electrode terminal on the feed hole side.....TL

Outline Drawing
2SB1205S-TL-E, 2SB1205T-TL-E



Land Pattern Example

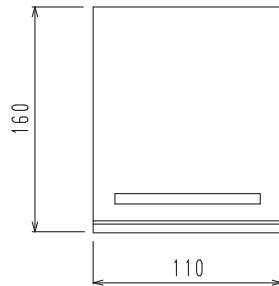
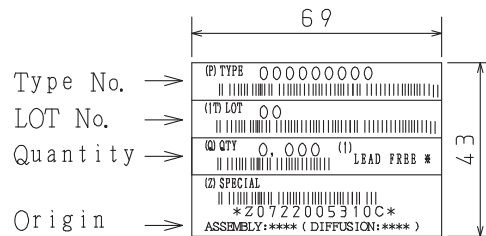


Bag Packing Specification

2SB1205S-E, 2SB1205T-E

1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			
	Bag	Inner box	Outer box	
TP	500	B-1	A-1	A-2
		10, 000	50, 000	30, 000
		Packing format (Dimensions:mm (external))		
		Inner box	Outer box	
		B-1	A-1	A-2
		445×225×55	470×250×300	470×250×190

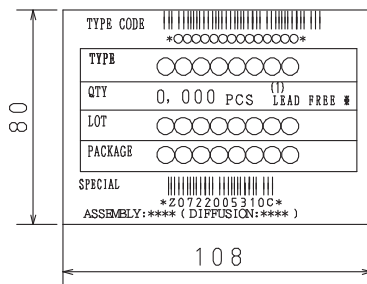
2. Bag dimensions
(unit:mm)3. Bag label, Inner box label
(unit:mm)4. Outer box label
(unit:mm)

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process,

NOTE (1)

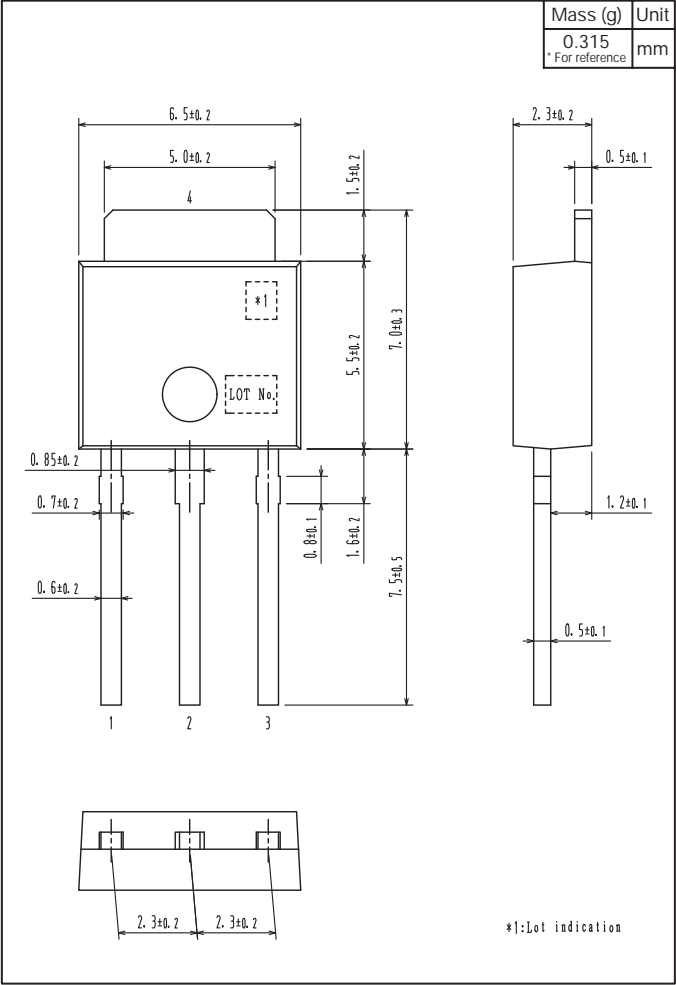
The LEAD FREE * description shows that the
surface treatment of the terminal is lead free.

Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3



Outline Drawing

2SB1205S-E, 2SB1205T-E



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